

SUBJECT: RoHS Compliance Labeling – JEITA Standard ET-7001

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EFFECTIVE DATE: Running change from December 1, 2005 through March 31, 2006. Scheduled completion of this change on a production basis is: April 1, 2006.

LAST TIME ORDER DATE: N/A

LAST TIME SHIPMENT: N/A

SUGGESTED REPLACEMENT: N/A

OTHER DETAILS:

We are changing innermost packaging labeling from the current JEITA draft document, e.g., “R-Pb”, “NoPb” lead (Pb) content to RoHS compliance marking per the new JEITA Standard using the letter G:

G or [[G]] .

Innermost packaging label examples: Reel face label, bulk bag label, tape and ammo box label, etc.

There is no indication of whether a RoHS exemption is used. Typical exemptions are: lead (Pb) in glass in electronic components (Thick Film Chip Resistors), lead (Pb) in ceramic in electronic components (some MLCC’s), and lead (Pb) in high temperature internal solder (various components).

